

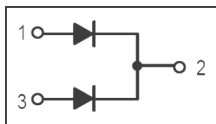
/ Descriptions

TO-3P

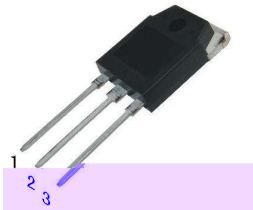
/ Features

/ Applications

/ Equivalent Circuit



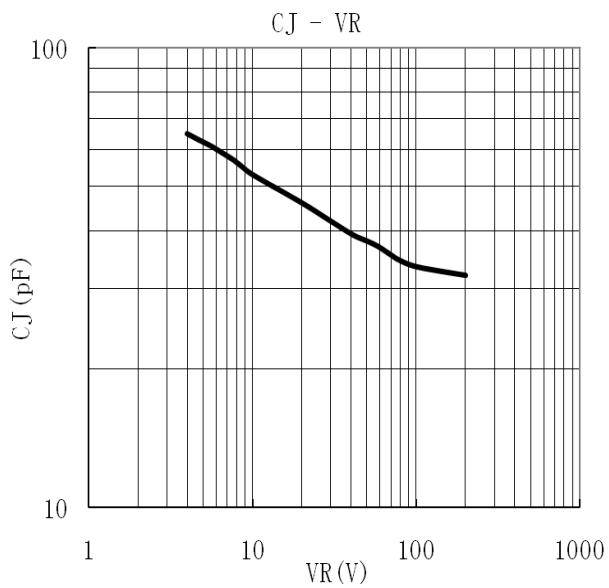
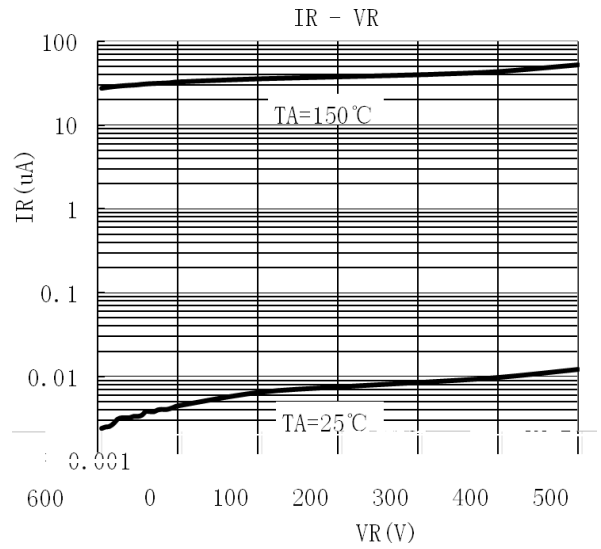
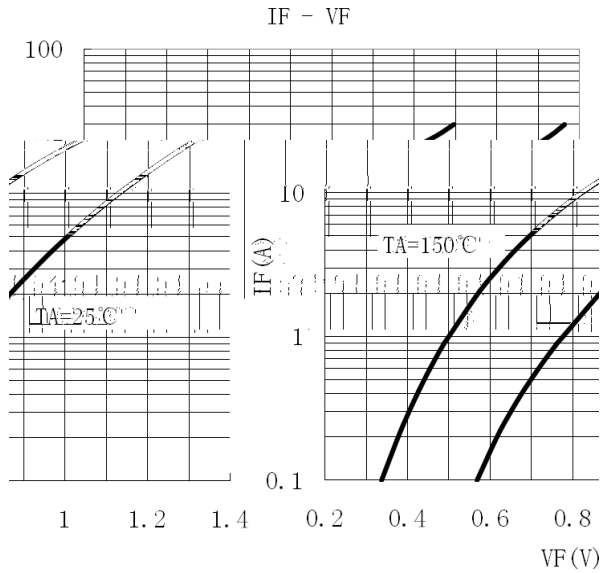
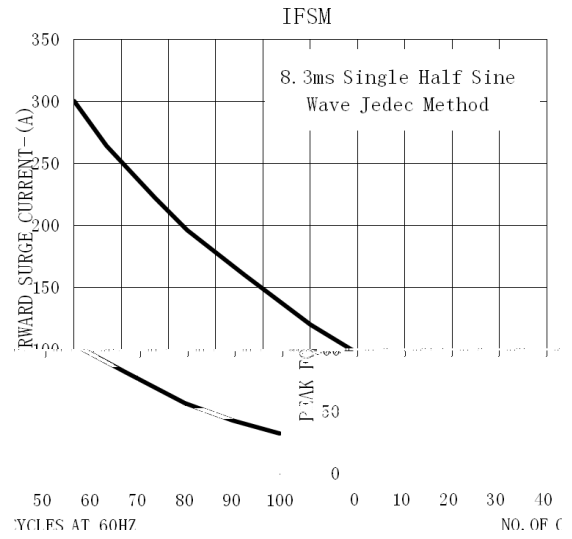
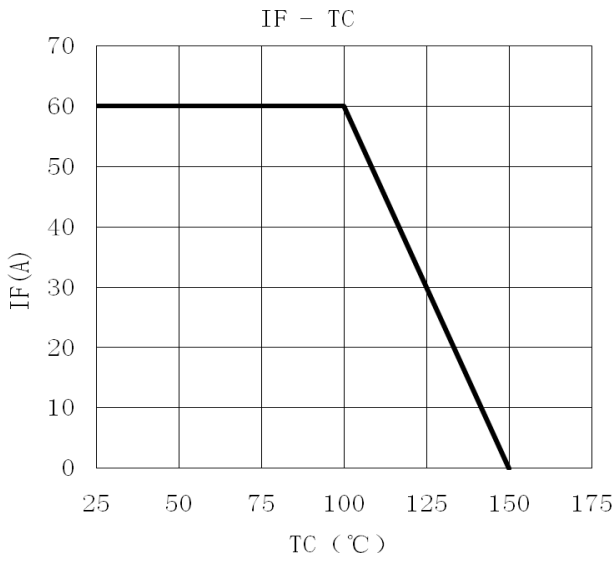
/ Pinning



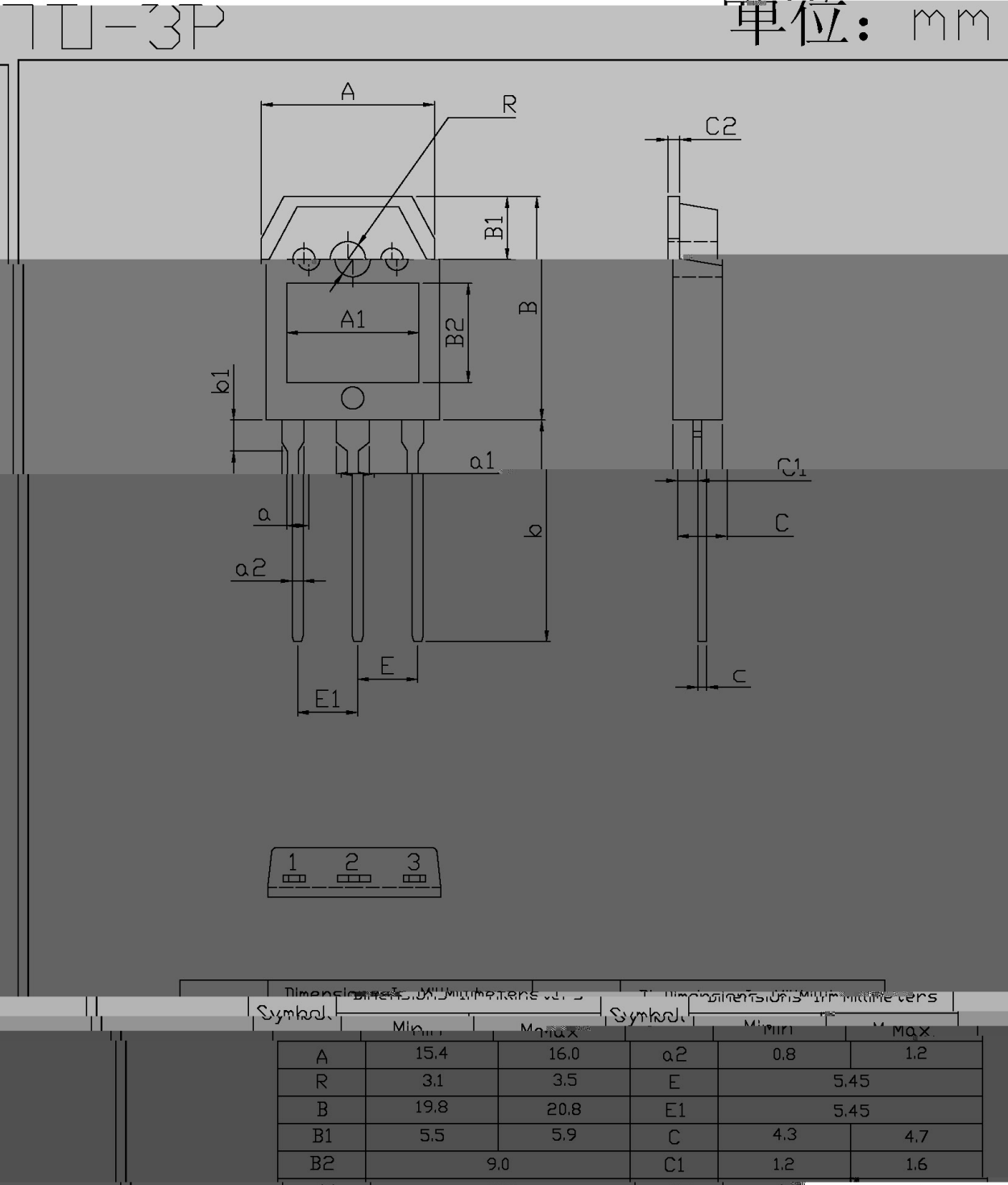
/ h_{FE} Classifications & Marking

		x	
	θ		

/ Electrical Characteristic Curve

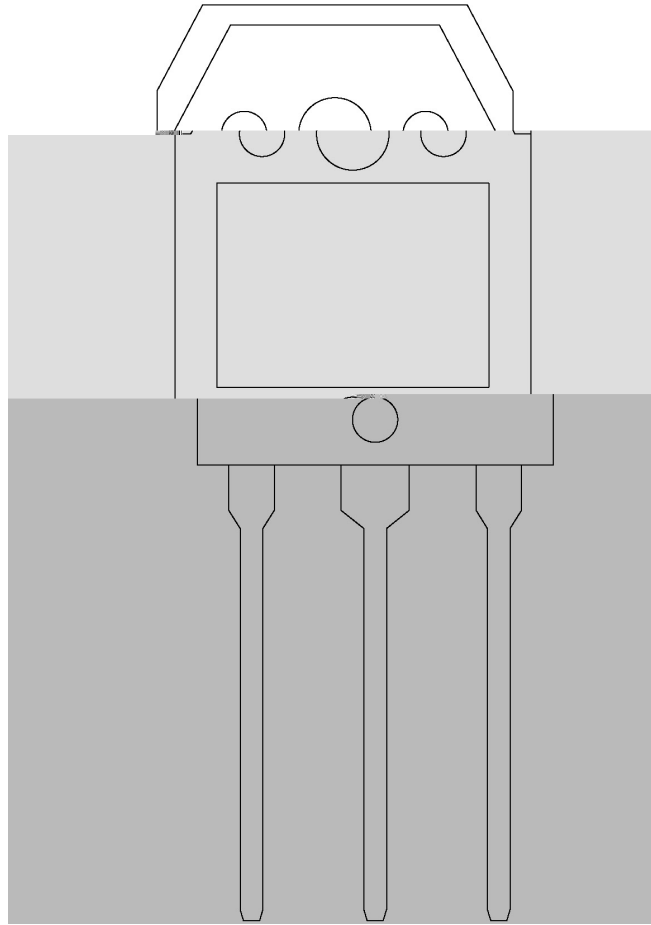


/ Package Dimensions



a	2.8	3.2			
a1	2.8	3.2			

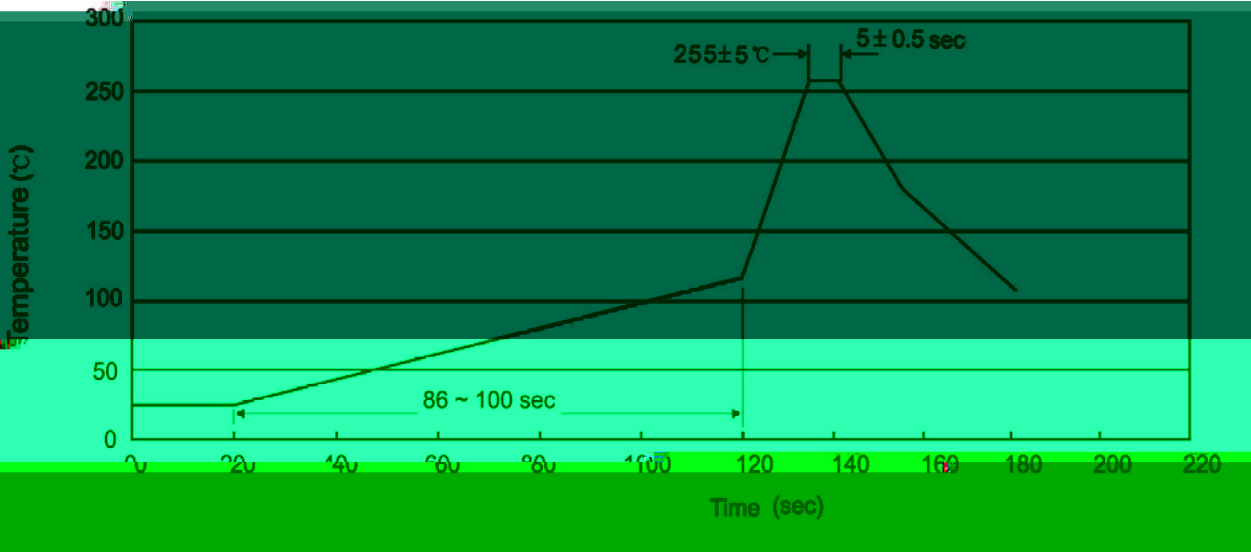
/ Marking Instructions



MUR6060PT

MUR6060PT

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱
								× ×

/ Notices